		STATES PATENT APPLICATION cations) (Atty. Docket:	MIYOSH0006
As a below named invent are as stated below next to one name is listed below) of below) of the subject matter entitled, (1) EPOXY RESIN MOLDINg the specification of which is on (3) June 12, 2006 (4) amended on (5)	my name. I believe in an original, first which is claimed a NG MATERIAL FOR SEALING s attached hereto unl	t and joint inventor (if nd for which a patent is AND ELECTRONIC COMPONENT less the following box is occurred to the control of the control o	nd sole inventor (if only plural names are listed sought on the invention checked: (2)
· · · · · · · · · · · · · · · · · · ·	reviewed and und claims, as amended ke tion which is matering 35 USC 119 of any sted below and have inventor's certification.	derstand the contents or any amendment referred to all to patentability as defunited States or foreign at also identified below any	to above. I acknowledge ined in 37 CFR 1.56. I pplication(s) for patent United States or foreign
Prior United States or Foreig	n Application(s)		
NUMBER (6) PCT/JP2004/018144	COUNTRY PCT	DAY/MONTH/YEAR FILED	PRIORITY CLAIMED
(6) <u>PC1/JP2004/018144</u>	JP	6 <u>December 2004</u> 11 December 2003	[X] Yes [] No [X] Yes [] No
2004-260963	JP	8 September 2004	[X] Yes [] No [] Yes [] No
I claim the benefit und insofar as the subject matter prior United States applicate acknowledge the duty to discort T.56 which became availation or PCT international filing decreases.	er of each of the claion in the manner polose information whingle between the filit	rovided by the first para ch is material to patental ng date of the prior appli	is not disclosed in the graph of 35 USC 112, I bility as defined in 37
Appln. Serial No.	Filing Date		
(7)		Status: [] Patented [] Status: [] Patented []	Pending [] Abandoned) Pending [] Abandoned)
I appoint Joerg-Uwe Szi Reg. No. 54,402, and Griffin power of substitution and rev the Patent and Trademark Off is Griffin & Szipl, PC, St Telephone No. (703) 979-5700,	& Szipl, P.C., indivocation, to prosecute ice connected therew uite PH-1, 2300 9th	e this application and to tith, and with the resultin	torneys/agents with full transact all business in g patent. Whose address
I declare that all state made on information and belie with the knowledge that will imprisonment, or both, under validity of the application o	of are believed to be ful false statements 18 USC 1001 and that	and the like so made are t such willful false stater	ese statements were made punishable by fine or
The undersigned hereby hereon any further identific document.	y authorize(s) Griff: cation or correction	in & Szipl, P.C. of the a n necessary or desirable	bove address to insert for submission of this
(8) Full name of sole or firs	t inwenter Kazuyoshi TE	ENDOU	
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		Citizens	ship
Post Office Address			
(1) Insert title of invention (2) Check block for PCT applic	•		d complete items (3)
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⁽⁴⁾ and (5). If PCT national phase entry application, insert international PCT application filing date, Serial No., and date of any Article 19 amendments.
(6) Complete for foreign priority documents; add additional page if needed.
(7) Complete for earlier US parent applications; add additional page if needed.
(8) Complete ALL blanks. Attach second page for further joint inventors.